

RX66T e-AI Motor Failure Detection Sample Software

Application Note

Introduction

This application note provides a usage example of e-AI (embedded Artificial Intelligence) described through sample software with an additional function that detects motor abnormality in a motor control system using RX66T.

The sample software comes with learned Deep Neural Network (DNN). The e-AI system operations can be immediately confirmed on the required hardware described in this document.

The software described in this application note is for reference use only. Operations are not guaranteed by Renesas Electronics. When using the software described in this application note, fully evaluate in an applicable environment before use.

Target Device

Operations with the software described in this application note have been confirmed for the following device.

RX66T (R5F566TEADFP)



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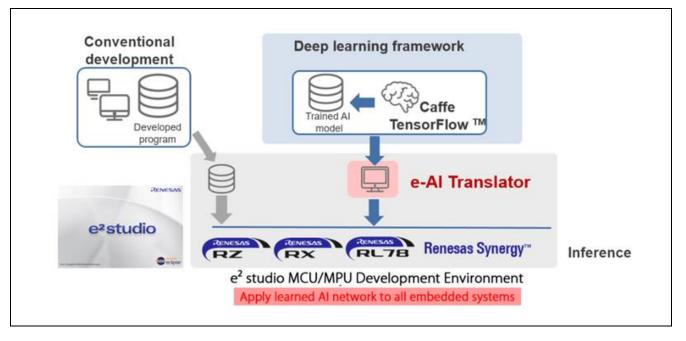


1. Introduction

Beginning with Endpoint Intelligence, Renesas aims to contribute to the realization of an eco-friendly, smart society that supports safer and healthy living in areas where this cannot be solved simply by using big data in the cloud. With its flexible and scalable embedded artificial intelligence (e-AI) concept, Renesas offers a future-proof, real-time, low power AI processing solution that is unique in the industry and addresses the specific needs for artificial intelligence in embedded devices at the endpoint.

Anyone can use AI (Artificial Intelligence) relatively easily by using Caffe developed by UC Berkeley or TensorFlow developed by Google. Although AI's specialty field varies according to the algorithm used, DNN (Deep Neural Network), a multi layered network, is used for embedded AI. Through an algorithm that learns input information that is labelled normal / abnormal DNN has dramatically improved the estimation of a failure condition. DNN has a large difference in the amount of computation required for learning and inference execution, and it is a major feature that it can be executed with less computing power in the inference phase. Focusing on the asymmetry of this computing power and for its main use for inference execution in embedded devices, we named this AI "e-AI" (embedded-AI).

The e-AI development environment solves these problems and makes it possible to implement learned DNN results onto an MCU/MPU in conformance with an e² studio C/C ++ project.





2. Overview

Figure 2-1 shows the system block diagram of the e-AI Motor Failure Detection Sample Software. This example is an e-AI-based motor status (abnormal value) display system in which learned DNN is added to the brushless DC motor control MCU software. The AI inference results are displayed via computer software.

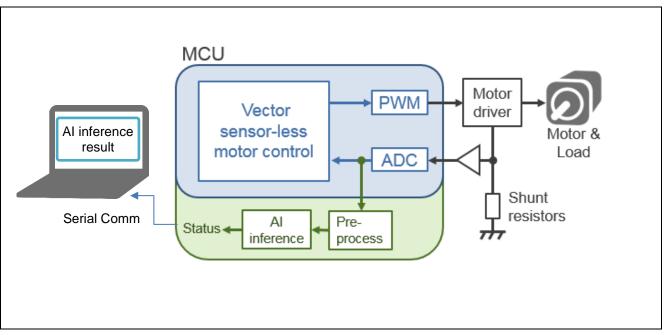


Figure 2-1. System Block Diagram

The AI inference process of this example performs the following operations.

- 1. Collect A/D conversion values of the three-phase current and generate an FFT frame.
- 2. Pre-processing before learned DNN input data
 - A. FFT processing of data frames (frequency spectrum generation)
 - B. Feature point extraction from frequency spectrum (learned DNN input data generation)
- 3. Al inference

The system's brushless DC motor control employs the sensorless vector control method to monitor the 3 shunt current control with the A/D converter. In this system, focusing on the fact that the waveform of the 3 shunt current changes depending on the state of the motor, this 3 shunt current is used as the input of trained DNN. A/D conversion values are accumulated for a fixed time to obtain waveform data on the time axis.

In input data pre-processing, a frequency spectrum is generated via FFT making it easier for AI to detect feature points of the 3 shunt current waveform. The FFT inputs data units with coefficient of 2 as one frame, but also generates a frame to partially overlap the preceding and following frame to detect changes at frame breaks. This is a common method often referred to as "overlap analysis." In addition, in the e-AI system with limited storage area, reduction of the DNN network layer is a benefit, allowing extraction and use of areas around the input data feature point. See [4.7.4Preprocessing specifications] for details.



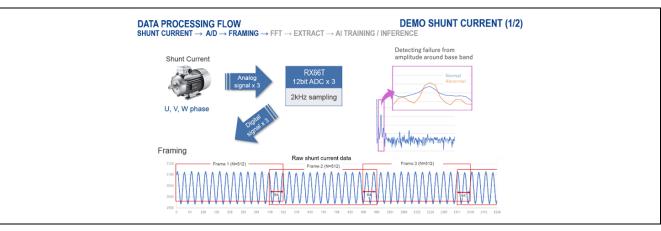


Figure 2-2. Data Processing Flow (1/2)

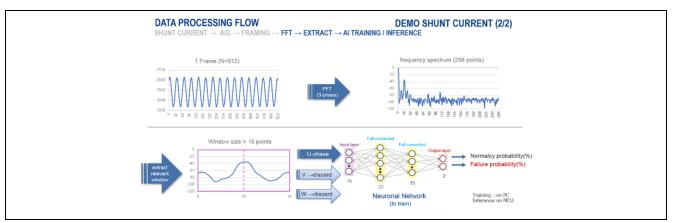


Figure 2-3. Data Processing Flow (2/2)

Al inference results are displayed in the PC software (DataCollectionTool). In addition to the Al inference results, this sample software also displays the 3 shunt current A/D conversion value and the spectrum waveform. The system's waveform data log function allows the system to accumulate NN training data while displaying waveforms.

Further details concerning the Data Collection Tool can be found in section 5. Data Collection Tool.

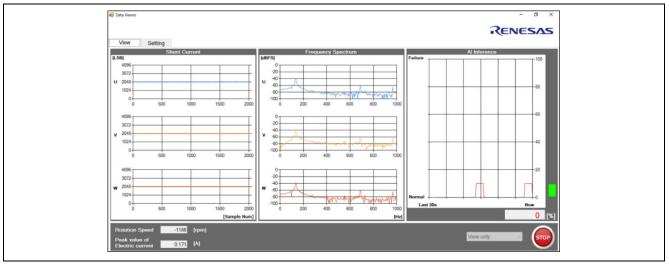


Figure 2-4. DataCollectionTool - Appearance

3. Specification

3.1 **Operating Conditions**

Table 3-1 lists the confirmed operation conditions.

Table 3-1. Operating Conditions

ltem	Description		
MCU	RX66T (R5F566TEADFP)		
Operating Frequency	Main clock: 8 MHz crystal oscillator		
	CPU clock (ICLK): 160MHz		
	Peripheral module clock A (PCLKA): 80MHz		
	Peripheral module clock B (PCLKB): 40MHz		
	Peripheral module clock C (PCLKC): 160MHz		
	Peripheral module clock D (PCLKD): 40MHz		
	FlashIF clock (FCLK): 40MHz		
Operating Voltage	5.0V (RX66T)		
Operating Mode	Single-chip mode		
Endian	Little Endian		
Integrated	Renesas Electronics e ² studio V7.2.0		
Development			
Environment			
C Compiler	Renesas Electronics CC-RX: V3.00.00		
	Compiler option: -isa=rxv3 -fpu -save_acc		
Auto generation tool	Renesas Electronics RX Smart Configurator V2.0.0		
Emulator	Renesas Electronics E2 Lite emulator		
Middleware	Renesas Electronics RX Family RX DSP Library Version 5.0		
e-AI Development	Renesas Electronics e-AI Translator V1.0.2		
Environment			
Evaluation Board	Renesas Electronics		
	24V Motor Control Evaluation System for RX23T (RTK0EM0006S01212BJ)		
	24V inverter board		
	Renesas Electronics RX66 CPU card (RTK0EMX870C00000BJ)		
Motor	Tsukasa Electronics Co. Ltd. TG55-L (RTK0EM0006S01212BJ bundled)		
	Simplified Motor Bench (see note)		

Note: For more details, refer to Appendix entitled "Simplified Motor Bench Assembly Guide."



3.2 Hardware Diagram

Figure 3-1shows the hardware block diagram of the e-Al Motor Failure Detection Sample Software. This sample is based on the hardware structure described in Reference Document [2]: "RX66T Application Note for Sensorless Vector Control of Permanent Magnetic Synchronous Motor," and is enhanced with a communication function and drive motor load device. For details on the hardware structure that serves as the base, please refer to Reference Document [2].

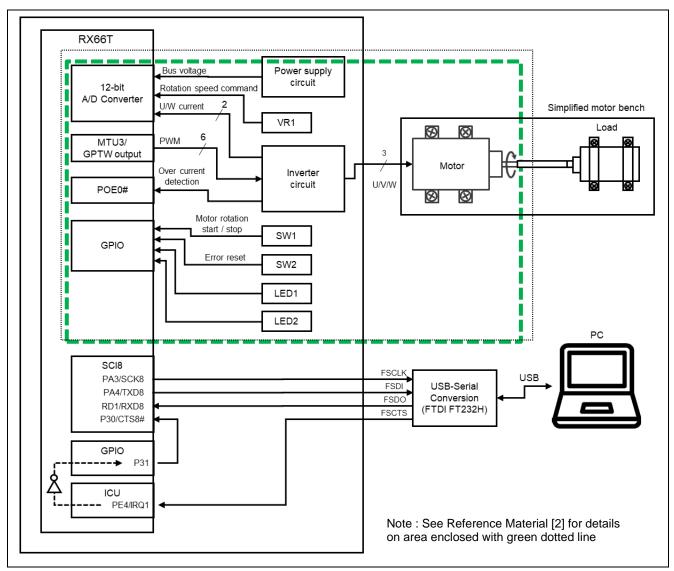


Figure 3-1. Hardware Block Diagram



3.3 **Operations Overview**

Figure 3-2 shows the system operation flow. The following is an overview of operations.

① Execute sensorless vector control on motor

When power is applied to the 24V inverter board, it is also applied to the RX66TCPU board, which starts the motor driver operations. See Reference Document [2] for processing details and Reference Document [3] for details on board operations.

2 Execute pre-processing for motor drive current data, determine abnormality using e-AI inference

 A/D conversion value accumulation CMT1 generates the 2kHz sampling frequency and acquires the A/D conversion value of the motor 3 shunt current. The 3 shunt current is input to the 12-bit A/D converter (S12ADH). One frame (512 samples) of A/D conversion values are accumulated for the FFT. From the next frame on, A/D conversion values are accumulated by overlapping 64 samples of the previous frame.

- Data pre-processing The MCU performs the FFT operation using the RX DSP library. The frequency spectrum resulting from the FFT operation is converted into dBFS. This sample software defines 0dB = 4095LSB @ S12ADH Full Scale. Next, the peak value of the frequency spectrum (excluding the DC component) and the previous and successive 8 samples (A/D conversion values) are selected to extract the frequency spectrum feature points.
- 3. Al inference

The extracted feature points are input to the trained DNN, and the probability of the two classes (normal and abnormal) are output by inference. In this example, the probability of abnormality is taken as the degree of abnormally.

③ Serial communication with PC

Using SCI8 in the SPI mode, data is transferred to the PC using a USB-serial converter cable. DMAC0 is used to transfer data to the SCI8's 'transfer data register' (TDR)

④ Display degree of abnormality and current waveform data in tools

The received data is displayed in numerical values and graph form in the DataCollectionTool (GUI tool) run on the PC.

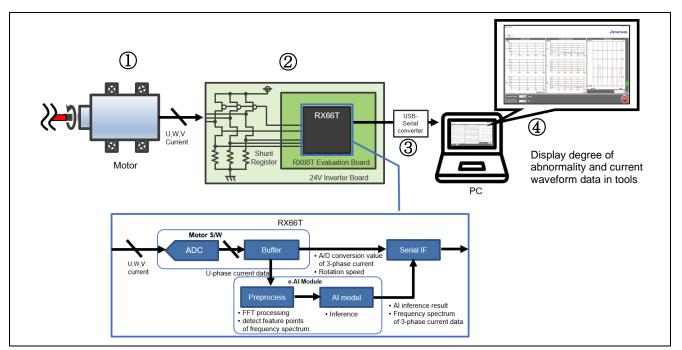


Figure 3-2. System Operation Flow



Figure 3-3 shows images of the system in normal and abnormal states. Normal state is defined as when the drive motor and load motor shafts form a single line and abnormal state is defined as when the axis of the two shafts is deviated. In this example, normal and abnormal states are recreated using a simple motor bench, coupling the drive motor and load motor shafts with a tube.

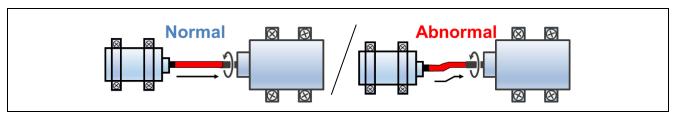


Figure 3-3. Images of Normal and Abnormal States

3.4 State Transition

Figure 3-4 provides an image of the state transition. The SW1, SW2, VR1, LED1 and LED2 discussed in this section indicate the devices mounted on the 24V inverter board of the 24V Motor Control Evaluation System for RX23T. RESET button refers to a device mounted on the RX66 CPU card.

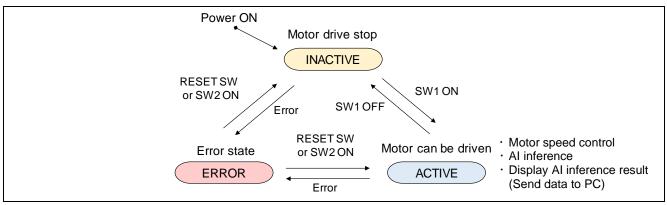


Figure 3-4. State Transition

(1) INACTIVE

INACTIVE indicates the state immediately after power is supplied to the system. The motor is not driven in this state. When SW1 is turned ON, the system transitions to ACTIVE state. If an error is detected in the inactive state, the system shifts to the error state.

(2) ACTIVE

In the ACTIVE state, LED1 goes on and the motor can be driven. The following processes are carried out in the ACTIVE state.

- Motor rotation speed control
 VP1 controls the rotation append of
 - VR1 controls the rotation speed of the motor.
- e-Al inference

Infers the degree of motor abnormality.

Data transfer to PC

Sends the motor drive current data and/or inference result to the PC.

When an error occurs in the ACTIVE state, the system transitions to the ERROR state.

(3) ERROR

When motor overcurrent or other error is detected, the LED2 lamp goes on and the system transitions to the ERROR state. To clear the error and return to the INACTIVE/ACTIVE state, push the RESET button or turn SW2 ON -> OFF.



4. MCU Software Explanation

4.1 **Software Configuration**

Figure 4-1 shows the software configuration of the e-AI Motor Failure Detection Sample Software. This sample is based on the sample software described in Reference Document [2]: "RX66T Application Note for Sensorless Vector Control of Permanent Magnetic Synchronous Motor," and is enhanced with AI inference logic, related drivers, and RX Family RX DSP Library. For details on the sample software, please refer to Reference Document [2].

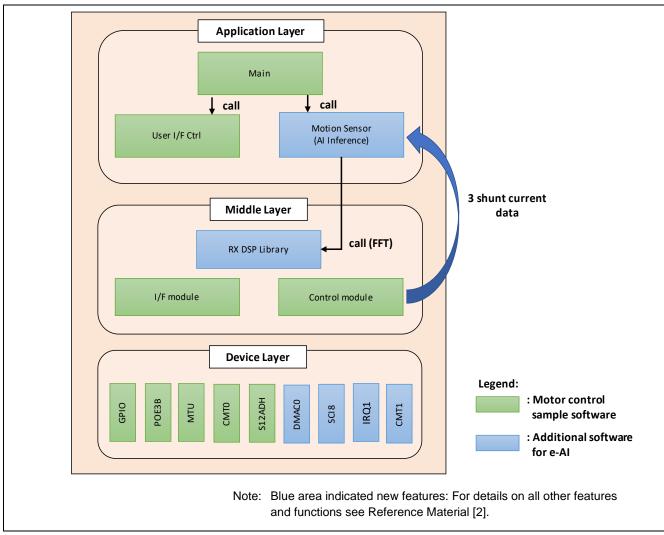
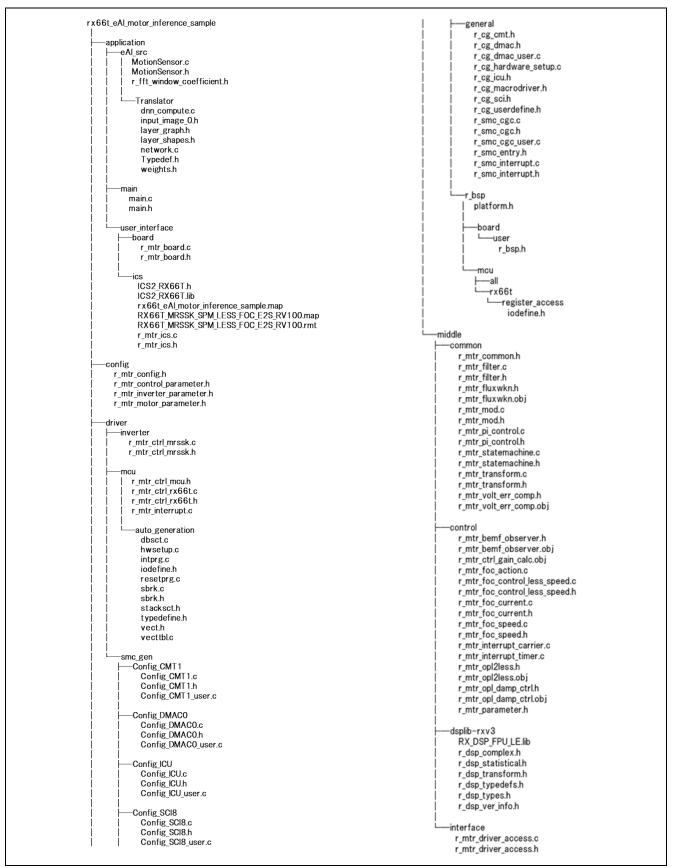


Figure 4-1. Software Configuration Overview



4.2 **Directory Configuration**

Figure 4-2 shows the directory configuration of the e-AI Motor Failure Detection Sample Software.







4.3 **Resources**

4.3.1 Resource List

Table 4-1 provides a list of resources used in the sample software. The items in bold are added peripheral functions unique to this software. Refer to Reference Document [2] for details on peripheral functions other than those in bold lettering.

Table 4-1. Resource List

Item	Description		
Clock generation circuit	Generates operating clock from external oscillator.		
S12ADH	3 shunt current measurement		
	Inverter bus line voltage measurement		
	Rotation speed command value input		
СМТО	500μs interval timer		
MTU3	Complementary PWM output		
POE3B	Overcurrent detection, output short circuit detection		
GPIO	Switch (SW1, SW2) input		
	LED (LED1, LED2) ON/OFF control		
CMT1	Generates 3 shunt current value sampling frequency (2kHz)		
SCI8	Serial communication (SPI)		
DMAC0 Transfers data to 'send data register' based on SCI8 trans			
	request		
ICU (IRQ1)	Rising and falling edges of pin level generate interrupt		
I/O Port (P31)	Outputs signal as inverting the level of the IRQ1 pin		

4.3.2 Interruptions

Table 4-2 provides a list of interrupt processings. The items in bold are added peripheral functions unique to this sample software. Refer to Reference Document [2] for details on interrupts other than those in bold lettering.

Table 4-2. Interrupt Processings

Interrupt request generation source (peripheral module)	Name (peripheral module name)	Interrupt priority level (IPR)	Description
Group Interrupt 1 (POE3) (SCI8)	GROUPBL1 (OEI1) (TEI8、ERI8)	15 (highest)	 Motor interrupt processing (overcurrent detected) Data send/receive to/from PC 'SCI8 send complete interrupt' (TEI8) 'SCI8 receive error interrupt' (ERI8)
PERIA(MTU3)	INTA209(TCIV4)	12	Motor interrupt processing (500 µs)
ICU	IRQ1	12	Monitors the level of flow control signal during serial communication.
SCI8	RXI8	12	Data receive from PC
CMT0	CMI0	11	Motor interrupt processing (50 µs)
SCI8	TXI8	8	Data send to PC (DMAC transfer trigger)
DMAC0	DMACI0	8	Clears 'transfer complete flag'
CMT1	CMI1	5	3 shunt current sampling frequency (2kHz)



The following shows the interrupt processing change point for this sample software.

 File name: intprg.c The following codes are commented out.

```
void Excep_CMT1_CMI1(void) { }
void Excep_SCI8_RXI8(void) { }
void Excep_SCI8_TXI8(void) { }
void Excep_DMAC_DMACOI(void) { }
```

② File name: r_mtr_interrupt.c

Processings added to external variable and external function declarations, over-current detection interrupt process (Group 1 interrupts) and 50[µs] period interrupt (carrier interrupt) process.

```
/* Use in e-AI processing */
extern float g current = 0;
extern void r Config SCI8 transmitend interrupt(void);
extern void r Config SCI8 receiveerror interrupt (void);
_____
#pragma interrupt (mtr over current interrupt(vect = VECT ICU GROUPBL1))
static void mtr over current interrupt (void)
{
   if (1 == ICU.GRPBL1.BIT.IS9)
   {
      mtr over current(&g st foc);
   }
   /* SCI8 TEI8 (transmit end) */
   if (1 == ICU.GRPBL1.BIT.IS24)
   {
       r Config SCI8 transmitend interrupt();
   }
   /* SCI8 ERI8 (recieve error) */
   if (1 == ICU.GRPBL1.BIT.IS25)
   {
       r_Config_SCI8_receiveerror_interrupt();
   }
} /* End of function mtr over current interrupt */
_____
#pragma interrupt (mtr_tciv4_interrupt(vect = VECT_PERIA_INTA208))
static void mtr tciv4 interrupt(void)
{
   mtr foc interrupt carrier(&g st foc);
   mtr_ics_interrupt_process();
   /* get peak current for e-AI process */
   if (g current < g st foc.f4 iu ad)
   {
       g_current = g_st_foc.f4_iu_ad;
   }
} /* End of function mtr tciv4 interrupt */
```



4.4 Main Processing

Figure 4-3 shows the flow chart for main processing. Motor control interrupt processing is also included to help clarify the relationship between main processing and motor control processing.

Main processing executes system initialization, then executes a loop of user interface processing and AI inference processing. User interface processing uses the 24V inverter board devices (SW1, SW2, VR1) to control the system, converts the input device information to system state and motor rotation speed command values, and passes this on to the motor control processing.

Motor drive control is performed by 2 types of motor interrupt processing. The motor can be driven when the system state is ACTIVE.

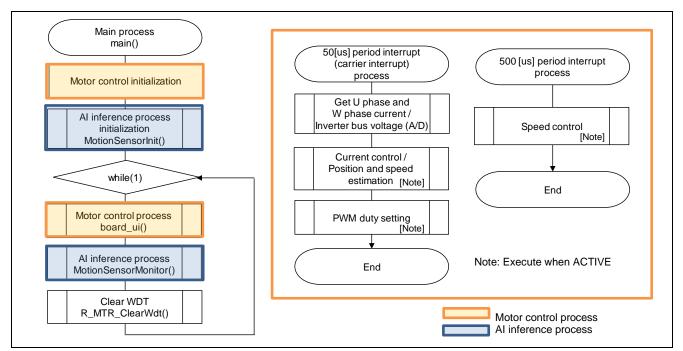


Figure 4-3. Main Processing Flow Chart

4.5 Motor Control Processing

This section describes only areas of the Reference Document [2] "RX66T Application Note for Sensorless Vector Control of Permanent Magnetic Synchronous Motor," that have been changed for this sample software. Please refer to Reference Document [2] for details on all other motor control processings. In this example, the following definition has been changed in order to employ the 24V inverter board user interface.

Target file: : r_mtr_config.h

Before change:

#define CONFIG_DEFAULT_UI (ICS_UI)
After change:
#define CONFIG DEFAULT UI (BOARD_UI)



The user interface processing code (board_ui function) has been rewritten for this example in order to limit motor rotation speed.

Item		Conversion Rate (command value: A/D conversion value)	
Rotation speed command value	CW	1000[rpm]~2000[rpm] : 08C8H~0FFFH	

Target file: main.c

Target function: board_ui()

Before change:

```
/*=======*/
/* Set speed reference */
/*=========*/
u2_temp_vr1_signal = get_vr1();
s2_temp = (u2_temp_vr1_signal - ADJUST_OFFSET) * VR1_SCALING; /* Read speed reference
from VR1 */
```

After change: :

```
/*======*/
/* Set speed reference */
/*======*/
u2 temp vr1 signal = get vr1();
s2_temp = u2_temp_vr1_signal - ADJUST_OFFSET; /* Read speed reference from
VR1 */
/* Change VR1 A/D value to rotation speed command value of +1000 to +2000rpm*/
/* The area near the VR1 center is the dead zone. */
if(-200 \ge s2 temp)
{
    s2_temp = (int16_t)(((0.542f * (float)s2_temp) -- 891) * (-1));
}
else if(200 <= s2 temp)
{
    s2_temp = (int16_t)(0.542f * (float)s2_temp) + 891;
}
else
{
    s2 temp = 0;
}
s2 temp = R MTR LimitAbs(s2 temp, g u2 max speed rpm);
R MTR SetSpeed(s2 temp); /* Set speed reference */
```



4.6 **FFT Processing**

The RX family uses the DSP library for FFT processing of the 3 shunt current data. Table 4-4 lists the functions used in the DSP library.

Table 4-4. Functions Used in DSP Library

Function Name	Description
R_DSP_FFT_Init_i16ci32()	Initialize handle for real FFT operation
R_DSP_FFT_i16ci32()	Real FFT transform (output FFT result as
	complex number)
R_DSP_VecCplxMag_ci32i32()	Acquire complex magnitude value

The following shows the FFT source code used by the RX DSP library for the example.

```
#include <r dsp transform.h>
static void fExecuteFFT (int16 t *pInBuf, float *pOutBuf)
{
    uint32 t i;
    uint16<sup>t</sup> SamplingHalf = gv SamplingConditions.m SamplingCount / 2;
    gs fft time.data = pInBuf;
    /* Real FFT transformation (output FFT result as a complex number) */
R_DSP_FFT_il6ci32( &gs_fft_handle, &gs_fft_time, &gs_fft_freq);
    /*
     * Obtain complex magnitude value
     * Analysis conditions when FFT length is 512 and the sampling frequency is 2kHz
* - frequency ticks: 2000Hz / 512 = 3.90625Hz)
     *
         - Measurable frequency: 3.90625Hz * 255 = 996.09375Hz
     */
    R DSP VecCplxMag ci32i32( &gs fft freq, &gs fft mag, SamplingHalf);
    /*
     * Replace 0th element of calculation result with gs fft buf[0].re
     * This process is necessary to remove the influence of real number half of the FFT
length.
    *(int32_t *) gs_fft_mag.data = gs_fft_buf[0].re;
    /*
     * Convert to dBFS(decibels below full scale)
     * Step1 : Convert fixed point number (1Q15) to floating point number.
* Divide FFT library output result (stored in int32 gs_fft_VecCplxMagi32[])
by (2^15-1).
                It is half the amplitude of the A/D full scale value.
     * Step2 : Double the result of step1 to get full amplitude of A/D full scale value
     * Step3 : Convert the result of step 2 to voltage-ratio(dB).
      * Step4 : Subtract 12bit A/D full scale voltage-ratio (72.247199 dB) to convert to
dBFS.
      * Note : The maximum magnitude that can be used for dBFS is OdBFS.
     * If an magnitude lower than this is used, a negative number will be displayed.
     */
    for (i = 0; i < SamplingHalf; i++)</pre>
    {
         if (0 != gs fft VecCplxMagi32[i])
             pOutBuf[i] = (20.0 * log10f((float) gs fft VecCplxMagi32[i] / 16383)) -
gv DecibelsBelowFullScale;
         /* When the complex absolute value is 0 */
         else
         {
             pOutBuf[i] = -gv DecibelsBelowFullScale;
         }
    }
}
```



The following shows the FFT initialization source code, which uses window function (hanning window) for the example.

```
static void fInitFft (void)
{
   uint16 t Count;
    /* Initialize FFT handle data */
    gs_fft_handle.n = gv_SamplingConditions.m_SamplingCount;
    gs fft handle.work = NULL;
    gs fft handle.options = (R DSP FFT OPT SCALE | R DSP FFT BIT REVERSAL DEFAULT |
R_DSP_FFT_OPT_TWIDDLE_DEFAULT);
   gs_fft_handle.bitrev = gs_fft_bitrev;
   gs_fft_handle.twiddles = gs_fft_twiddles;
   gs fft handle.window = NULL;
   gs_fft_time.n = gv_SamplingConditions.m_SamplingCount;
gs_fft_freq.n = gv_SamplingConditions.m_SamplingCount / 2;
   gs fft mag.n = gv SamplingConditions.m SamplingCount / 2;
    /* Set window coefficient according to FFT length */
      switch(gv SamplingConditions.m SamplingCount)
    ł
        case DEF_SamplingCount1024:
           gs_fft_handle.window = (void *) i16_hanning_fft1024;
           break;
        case DEF_SamplingCount512:
           gs fft handle.window = (void *) i16 hanning fft512;
           break;
        case DEF_SamplingCount256:
           gs fft handle.window = (void *) i16 hanning fft256;
           break:
        case DEF SamplingCount128:
           gs fft handle.window = (void *) i16 hanning fft128;
           break;
        default:
           gs fft handle.window = NULL;
           break;
    }
    /* Initialize FFT */
    R_DSP_FFT_Init_i16ci32( &gs_fft_handle);
    /* Sampling size */
    gv SamplingSize = (gv SamplingConditions.m SamplingCount * 2) -
gv_SamplingConditions.m_SamplingOverLap;
    gv_Buffer2to10verlap = gv_SamplingSize - gv_SamplingConditions.m_SamplingOverLap;
    /* End position of #1 frame */
   gv_Frame1End = gv_SamplingConditions.m_SamplingCount - 1;
    /* End position of #2 frame */
   gv Frame2End = gv SamplingSize - 1;
    /* (Sampling count/2)**2
                               */
    gv_SquareSamplingHalf = (float) ((gv_SamplingConditions.m_SamplingCount / 2)
            * (gv_SamplingConditions.m_SamplingCount / 2));
    /* Sampling frequency */
    Count = (uint16_t) (DEF_CMT_CLK8 / (float)
(gv SamplingConditions.m SamplingFrequency)) - 1;
    /* A/D conversion trigger timer setting */
   CMT1.CMCOR = Count;
}
```



4.7 Al Inference Processing

4.7.1 Flowchart

Figure 4-4 shows the flowchart for AI inference processing.

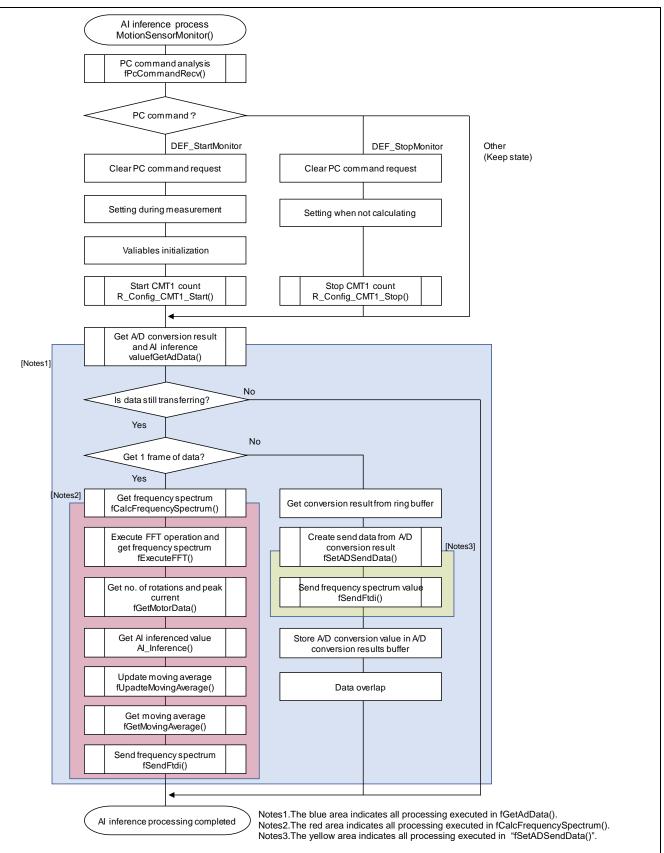






Figure 4-5 shows the flowchart for getting A/D conversion result of motor current value. This processing is performed by CMI1 interrupt.

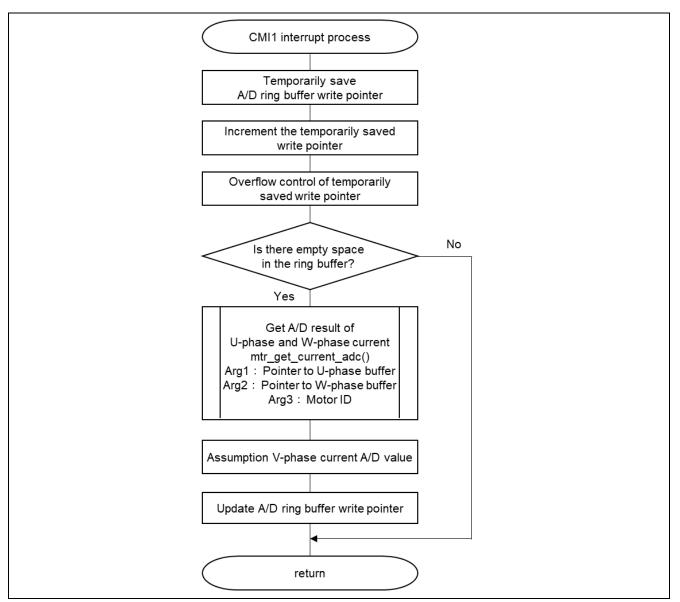


Figure 4-5. Flowchart for getting A/D conversion result of motor current value



4.7.2 Data Flow

Figure 4-6 shows the data flow for AI inference processing.

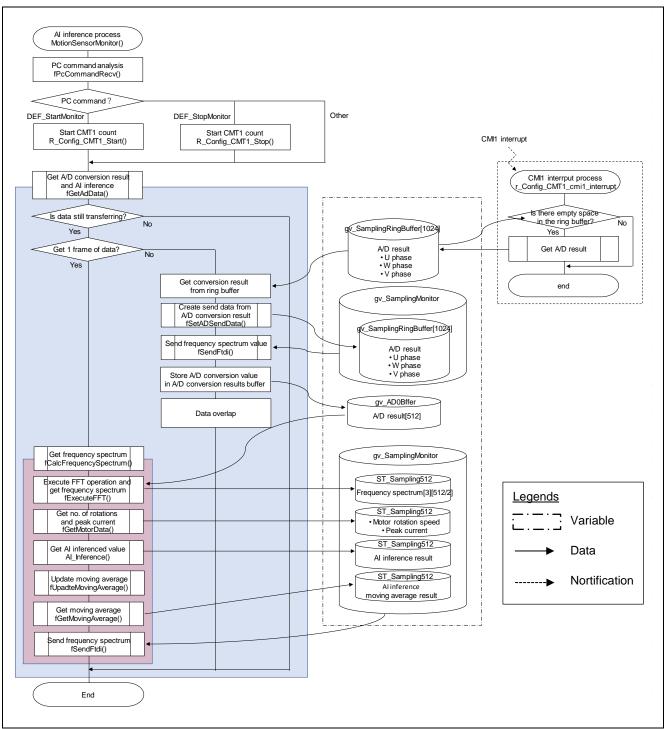


Figure 4-6. Al Inference Processing Data Flow



4.7.3 Al Model

Figure 4-7 shows the AI model configuration.

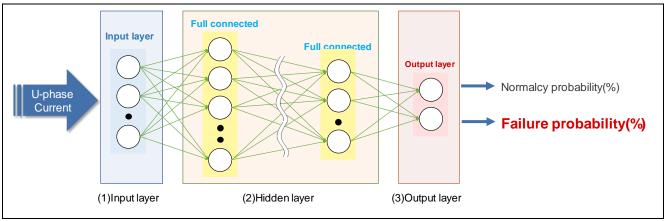


Figure 4-7. Al Model Configuration

(1) Input layer

FFT-processed U-phase shunt current data is input to the input layer

(2) Hidden layer

The hidden layer uses the fully connected layer.

(3) Output layer

The output layer outputs the probability of normality and abnormality.

Figure 4-8 shows the normal state and Figure 4-9 shows the abnormal state for this example. The degree of abnormality is inferred by e-AI from the difference in generated current waveform. In this software, axis deviation is defined as abnormal.

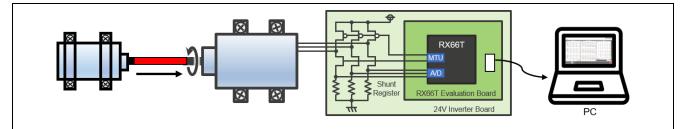


Figure 4-8. Normal State

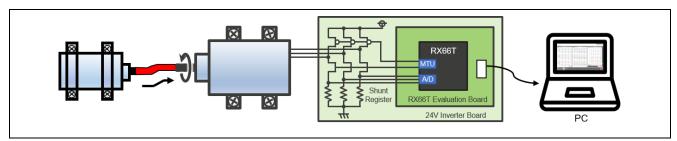


Figure 4-9. Abnormal State



4.7.4 **Preprocessing specifications**

The RX66T Motor Failure Detection Application described in this document (referred to as "target system" below) preprocesses motor drive current data for use as AI input data. The following outlines the preprocessing used by the target system.

- Framing
- Frames the A/D conversion value of motor drive current
- FFT
- FFT is performed on the A/D conversion value of the motor drive current framed to detect the feature value.
- Data extraction
- Extract data in the vicinity where the feature is detected.

The following describes preprocessing performed on the actual target system.

 shows the A/D conversion value of the motor drive current which is used as input data. This data must be framed every 512 points. To avoid missing data when collecting data, the frames are set so that 64 points overlap the previous frame. The waveform is output for 3-shunt current.

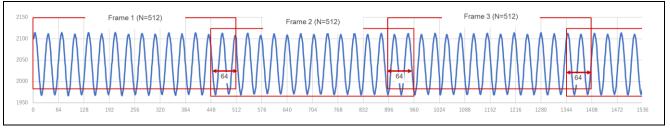


Figure 4-10. A/D Conversion Value of Motor Drive Current

- ② Feature values cannot be detected on the time axis, so the framed motor drive current A/D conversion value is FFT processed and converted to the frequency axis, as shown in Figure 4-11. Data Preprocessing Flow graph (a). In the target system, features are detected around the peak value of the fundamental frequency outlined in yellow in Figure 4-11. Data Preprocessing Flow graph (b).
- ③ A total of 16 points before and after the peak value where the feature value was detected are extracted, as shown in Figure 4-11 graph (c), and used as input data. Only the U phase is used as data for the AI model.

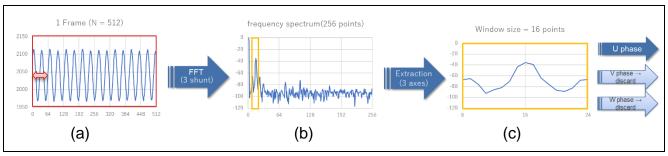


Figure 4-11. Data Preprocessing Flow



5. Data Collection Tool

5.1 **Operation Overview**

The waveform monitor tool is used to send the 3 shunt current data and AI inference value from the RX66T MCU in a serial communication, and to display those results. The tool does not require installation. An overview of the waveform monitor tool operations is as follows.

- Control display start/stop
- Display data sent from RX66T
 - 3 shunt current
 - Waveform data
 - Frequency spectrum (extracted by FFT)
 - Al inference result
 - Moving average waveform
 - Actual value bar (0~100% displayed in increments of 10%)
 - Numerical value
 - Motor rotation speed
 - Peak current value

5.2 Function Explanations

The following describes each waveform monitor tool function in detail. The tool has a **View** tab for displaying all categories of information and a **Setting** tab for setting up operations.

5.2.1 View Tab

Figure 5-1 shows the display layout used in the View tab. The numbers in the figure correspond to the numbers in the function descriptions below.

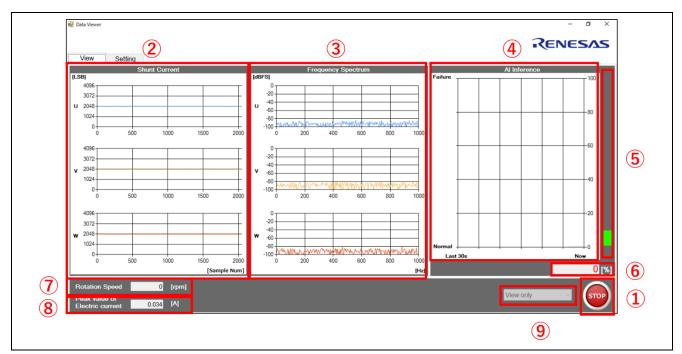


Figure 5-1. View Tab Display Specifications



① Control display start/stop

The START button is displayed as soon as the GUI software is started up. Each function is described below.

- When the START button is pushed:
 - 'Data Send Request Commands' are sent from the PC to RX66T, and data is sent from RX66T to the PC.
 - Received data is displayed in real time.
- When the STOP button is pushed:
 - 'Data Send Stop Command' is sent from the PC to RX66T and data acquisition ends.
- ② 3 shunt current waveform data

3 shunt current sampling data is plotted on a graph as U, V and W.

③ Frequency characteristics

The 3 shunt current waveform data in (2) above are transformed into the frequency spectrum via FFT, converted to dBFS and plotted on a graph.

④ Moving average waveform of AI inference result

The moving average of the abnormality probability output by AI inference is generated and plotted in a waveform graph.

(5) Al inference result indicator bar

Displays the abnormality probability output by AI inference in a stacked bar graph in 10% increments.

6 Al inference result in percentages

Displays the abnormality probability output by AI inference in percentages.

O Numerical value of rotation speed

Displays the motor rotation speed in numerical value.

8 Numerical value of peak current value

Displays the numerical value of the 3 shunt current's peak current value, which, in this example, is the U phase current's peak value.

④ Log function selection

User selects whether to output log (CSV file) from drop down list. The CSV file is stored in the "CSV Location" folder immediately under the C drive in the initial settings.

- View only
 - Only monitors various data.
- Save to CSV (divided)
 - Monitors various data and outputs logs. This setting outputs the sampling waveform and frequency spectrum (dBFS) to the file independently for each phase. Data is recorded after a line feed for every FFT frame.
- Save to CSV (combined)
 - Monitors various data and outputs logs. This setting outputs the sampling waveforms and frequency spectrums (dBFS) together in a single file. Data is added until the acquisition record is completed.



5.2.2 Setting tab

Figure 5-2 shows the display specifications for the Setting tab. The numbers in the figure correspond to the numbers in the function descriptions below.

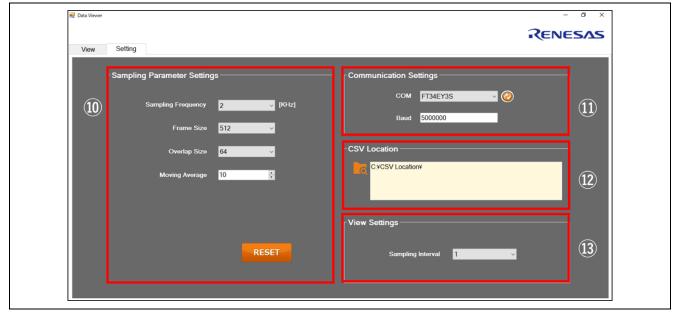


Figure 5-2. Setting Tab Display Specifications

10 Sampling parameter setting

The learned DNN in this example is optimized to the default setting except for the moving average.

- 1. Sampling Frequency
 - Specifies the sampling frequency (1/2/4/8 kHz, default: 2 kHz)
- Frame Size Specifies the FFT frame size (128/256/512/1024, default: 512).
- 3. Overlap Size
 - Specifies the FFT frame overlap size (16/32/64/128, default: 64).
- Moving Average Specifies the moving average of the graph for the AI inference result (specified range: 1 to 100 times, default: 10).
- (1) Communication setting
 - 1. COM

Acquires and displays the name of the FTDI device connected to the PC.

2. Baud

Specifies the Baud rate for communications between the MCU and PC (range: 9600 to 5000000, default: 5000000).

12 CSV storage location setting

Specifies the CSV file output location when the View tab is set to output logs.

13 View settings

Specifies the update interval of the view tab (1/2/4/8/16/32/64, default: 1).



5.3 **Operations**

1. Startup

Connect the Demo device and PC with a USB cable. Open the DataCollectionTool_for_RX.exe as shown in the figure.



Figure 5-3. DataCollectionTool_for_RX.exe file

If you open the exe file before connecting the demo device to the PC with a USB cable, you will get an error warning, as shown in Figure 5-4.

Initial setting X	
There are no FTDI device.	
ОК	

Figure 5-4. Error Display

The screen shown in Figure 5-5 appears when you open the exe file.

View Setting Shunt Curront	Frequency Spectrum	Al Inference
		<u>سا</u>

Figure 5-5. Initial Startup Screen



2. Start data acquisition

Push the START button shown in Figure 5-6, to start data acquisition



Figure 5-6. Data Acquisition Start Button

After data acquisition starts, the acquired data is displayed in the View screen.

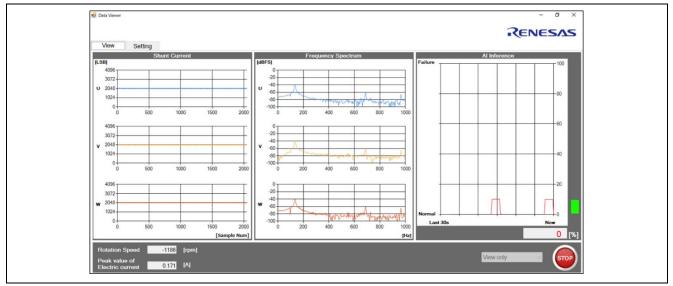


Figure 5-7. Screen During Data Acquisition

3. Stop data acquisition

Push the STOP button shown in Figure 5-8, to stop data acquisition.



Figure 5-8. Data Acquisition Stop Button



By selecting "Save to CSV(divided)" from the drop-down list shown in "5.2.1 View tab," you can output data for each axis and rotation speed/peak current data to CSV files while viewing the data. Figure5-9 shows the files created for saving the output data.

FFT_dbFS_20190409_141215_1.csv
FFT_dbFS_20190409_141215_2.csv
FFT_dbFS_20190409_141215_3.csv
SensorData_20190409_141215_1.csv
SensorData_20190409_141215_2.csv
SensorData_20190409_141215_3.csv
FFT_dbFS_20190409_141215_rotation_current_ai.csv

Figure 5-9. Files Created when is "Save to CSV(divided)" is Selected

In the same manner, by selecting "Save to CSV(combined)" you can output data for each axis in a single CSV file while viewing the data. Figure5-10 shows the file created for saving the output data.

SensorData_20190409_142153_123.csv

Figure 5-10. File Created when "Save to CSV(combined)" is selected

6. Reference Documents

- [1] RX66T Group User's Manual: Hardware (R01UH0749)
- [2] RX66T Sensorless vector control for permanent magnetic synchronous motor (Implementation) (R01AN4244)
- [3] Renesas Solution Starter Kit 24V Motor Control Evaluation System for RX23T User's Manual (R20UT3697)
- [4] RX66T CPU Card User's Manual (R12UZ0029)
- [5] RX Family RX DSP Library Version 5.0 (R01AN4359)
- [6] RX Family Sample Program for Performing FFT on Analog Input Signals (R01AN4015)
- [7] User's Manual for e-AI Translator (R20UT4135)
- [8] e2 studio Integrated Development Environment User's Manual: Getting Started Guide (R20UT4374)
- [9] Renesas Flash Programmer V3.05 Flash memory programming software User's Manual (R20UT4307)

[10] RX66T e-Al Motor Failure Detection Sample Software Al Model Development Quick Start Guide (R01QS0036)



Appendix1. Operation Confirmation Method

1. Usage Notes

The evaluation device (Simple Motor Bench) described in this section was not constructed for operations or evaluations conducted over a prolonged period. In addition, vibrations during motor operations may cause problems, such as parts becoming loose or falling off the device. Please give due consideration to safety when confirming operations using this device.

2. Evaluation Environment

Table 6-1 provides details of the hardware environment required for development of based on this sample software.

ltem	Name	Manufacturer	Spec/Model No. etc.	QTY
Evaluation	RX66T CPU card	Renesas	RTK0EMX870C00000BJ	1
board	24V inverter board	Renesas	RTK0EM0006S01212BJ	1
	24V AC adaptor	(general)	Output: over DC24V-2A	1
			Plug shape: diameter - external	
			5.5mm/internal 2.1mm	
			Center plus	
	USB serial converter cable	FTDI	C232HM-EDHSL-0	1
	(See note)		USB Hi-Speed to MPSSE Cable	
	Pin header	(general)	2.54mm pitch, 36 positions x 2 rows	1
Drive motor	Brushless DC motor	Tsukasa Electric	TG-55L	1
		Co. Ltd.	(bundled with RTK0EM0006S01212BJ)	
Simple motor	Universal plate	Tamiya Inc.	Item No:70098	1
bench	Planetary gear box set	Tamiya Inc.	Item No:72001	1
			Use one 4:1 gear unit	
	Rubber foot	(general)	-	4
	Air tube	(general)	External diameter: 4mm, internal	1
			diameter 2.5mm	
			Cut to 52mm	
	Banding band	(general)	Width: 2mm	4
PC for display	-	(general)	OS : Windows® 10	1
			Processor: 1.6GHz or more	
			Main memory: 1G Byte or more	
			Interface: USB2.0 (for E2Lite or USB-	
			serial cable connection)	

Table 6-1. Hardware Environment

Note: Depending on the operating environment, noise may be superimposed on the transfer data. If this occurs, try various measures such as adjusting the operating environment or making the cable shorter.



3. Simple motor bench assembly

This section describes how to assemble a simple motor bench. The complete bench is shown in Figure 1.

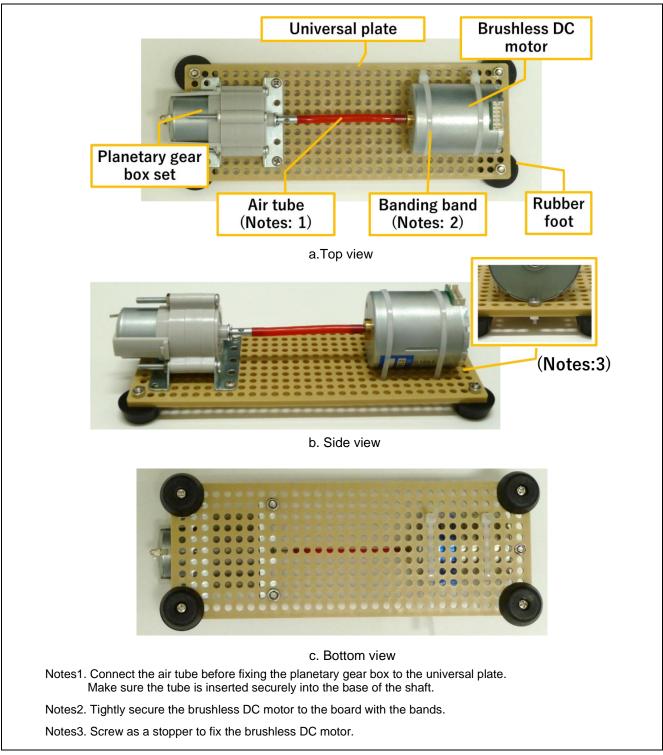


Figure 1. Simple motor bench - Appearance



Figure 2 shows the position of the holes for the banding band to secure the load motor.

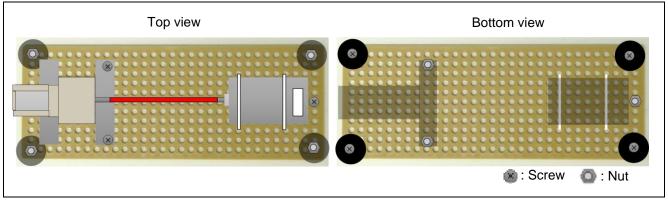


Figure 2. Simple motor bench - Parts location

4. USB-serial converter cable

USB-serial converter cable C232HM-EDHSL-0, manufactured by FTDI (Future Technology Devices International), is used for communication between RX66T and the PC.

- i. How to connect the cable
 - Solder the pin header (36x2) to the CNC through hole on the RX66T CPU board.
 - Referring to Table 6-2, connect the C232HM-EDHSL-0 pins to the CNC pin header. Connect pins 27 and 28 of the CNC pin header with short block jumper.

C232HM-EDHSL-0 pin assign		CNC pin header pin assign	
Function	Wire color	Pin No.	Function
FSCLK	Yellow	29	SCK8
FSDI	Orange	15	TXD8
FSDO	Green	35	RXD8
FSCTS	Brown	33	IRQ1
-	-	28 - 27 (Jumper short)	P31 -> CTS8#
GND	Black	31	GND

Table 6-2. USB-Serial converter cable pin connection list

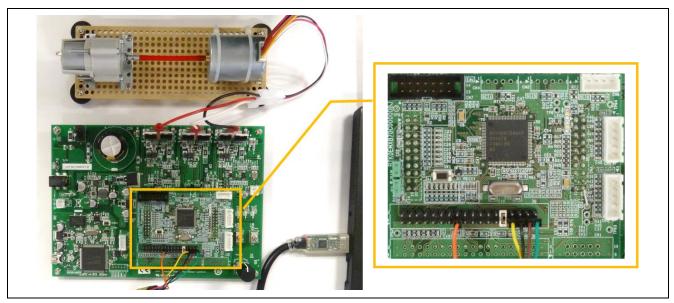


Figure 3. USB-Serial converter cable connection diagram



ii. Device Setting

Note that the FT232HL operating mode must be changed before attaching the USB serial converter cable. Please carry out the following steps to change the operating mode.

- ① Download the **FT_Prog** software from the FTDI site and install. http://www.ftdichip.com/Support/Utilities.htm#FT_Prog
- ② Download and install .NET Framework 4.0 which is required for running FT Prog. https://msdn.microsoft.com/ja-jp/vstudio/ff687189.aspx
- ③ After the above programs are downloaded and installed, execute FT_PROG.exe. Figure 4. shows the initial startup screen after executing FT_PROG.exe. Click the magnifying glass icon (circled in red in the figure) to view a list of connected FTDI devices. Connect the USB serial conversion cable here, then press the magnifying glass icon (circled in red). The connected devices will then be displayed on the screen.

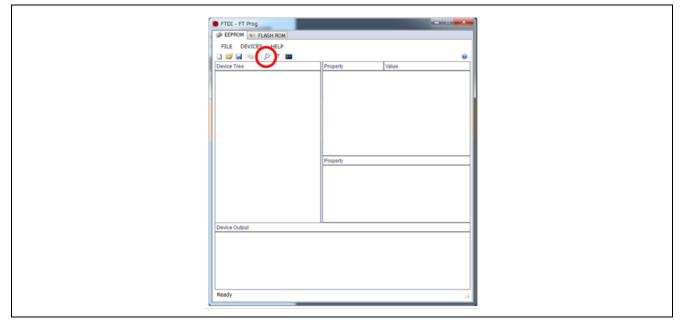


Figure 4. Initial Startup Screen

 ④ Make the following changes to operating modes as shown in Figure 5: [Hardware]→OPTO isolate, [Driver]→D2XX.

SEEPROM V FLASH ROM		SEEPROM SFLASH ROM	
FILE DEVICES HELP	0	FILE DEVICES HELP	0
Device Tree	Property Value	Device Tree	Property Value
□€- ■ ↓ <td>RS232 UART 245 FIFO CPU FIFO OPTO Isolate</td> <td>G → Device: 0 [Loc ID:0/216431] G → FT EEPROM G → Chip Details G → USB Device Descriptor G → USB String Descriptor G → USB String Descriptor G → USB String Descriptor G → Hardware Specific G → PartNavare Specific G → Suspend DOUS7 G → PortA G → Port B</td> <td>D2XX Direct Vitual COM Port</td>	RS232 UART 245 FIFO CPU FIFO OPTO Isolate	G → Device: 0 [Loc ID:0/216431] G → FT EEPROM G → Chip Details G → USB Device Descriptor G → USB String Descriptor G → USB String Descriptor G → USB String Descriptor G → Hardware Specific G → PartNavare Specific G → Suspend DOUS7 G → PortA G → Port B	D2XX Direct Vitual COM Port
Hardware → OPKT → 245FFO → 0PTO → 0PTO → 0PTO → 0CP → 0CP → 02XX ⊕ → 10 Pins	Property Hardware Each channel can be independently configured as RS232 UART/245FIFO/CPU FIFO or OPTO Isolate. See the Datasheets available from the FTDI website for further details.		Property Virtual COM Port / D2XX The driver that is installed and used by each channel can be se by selecting Virtual COM Port or D2XX Direct option.

Figure 5. "Hardware" Driver Setting Screen



5 Click the lightning icon (circled in red in Figure 6) to open the EEPROM program dialog

SEPROM V FLASH ROM	
FILE DEVICES HELP	
🗋 🐸 🖬 i 🛍 + i 🎗 🖉 📼	0
Device Tree	Property Value
	RS232 UART © 245 FIFO © CPU FIFO © OPTO Isolate ©
Hardware	Property
→ OKAT → 245FFO → CPUFFO → OPTO ⊖ Driver → VCP → 2020X ↔ OPTO ⊖ OPTO	Hardware Each channel can be independently configured as RS232 UART/245FIFO/CPU FIFO or OPTO Isolate. See the Datasheets available from the FTDI website for further details.
Device Output	
Device: 0 [Loc ID:0x216431]	*
Word MSB 0000: 0408 0403 6010 0700 4BA0 000 0008: 2EA4 12D2 0000 0000 0056 000 0010: 0000 0000 0000 0000 0000 000 0018: 0000 0000 0000 0000 0000 000 0028: 0000 0000 0000 0000 0000 000 0028: 0000 0000 0000 0000 0000 000 Ready	V 0000 0000 ······· 0 0000 0000 ······· 0 0000 000

Figure 6. Setting Screen

6 Press Program (circled in red in Figure 7.) to implement all of the changes. After a few seconds, the settings will be programmed to the EEPROM on the board.

Device List	Device Overview
☑ Device: 0 [Loc ID:0x216431]	Device: 0 [Loc ID:0x216431] Chip Type: 'FT2232H' Vendor ID: 0x0403 Product ID: 0x6010 Manufacturer: 'FTDI' Product Description: FT232H-56Q MiniModule
Select All Deselect Cycle Ports	Serial Number: FT287KYQ Auto-Generate Only Program Blank Devices Program Erase Close

Figure 7. FTDI Device Program Screen

After programming is completed, detach the USB-serial conversion cable from the PC. Once the cable is re-attached, the system will operate based on the new settings.



5. Write ROM file to the MCU

This section explains how to write a ROM file to the MCU using E2 Lite. Refer to Reference Document [4] "RX66T CPU Card User's Manual" for details on the position of the emulator connector for the E2 Lite connection.

1 e2studio

For instructions on how to import a sample project into e2 studio using E2Lite, refer to Reference Document [8] "e2 studio Integrated Development Environment User's Manual – Getting Started Guide.

2 Renesas Flash Programmer

For instructions on how to write a mot file with the Renesas Flash Programmer, refer to Reference Document [9] "Renesas Flash Programmer V3.05 Flash Memory Programming Software User's Manual."

Make sure to specify DefaultBuild/"Samplesoft name".mot of the sample software as in the path of the program file to be written to the MCU.

6. Operations

Refer to Reference Document [3] for explanations on how to supply the power, control the motor, and turn off the power.

Instructions on how to control the motor speed with VR1 are provided below. The letters and numbers correspond to indications in the figure.

- Rotation speed
 - STOP : Stop
 - MIN : 1000rpm
 - MAX : 2000rpm
- Note: Please operate the VR1 gently. Operating it too suddenly will cause the overcurrent protection to start up.

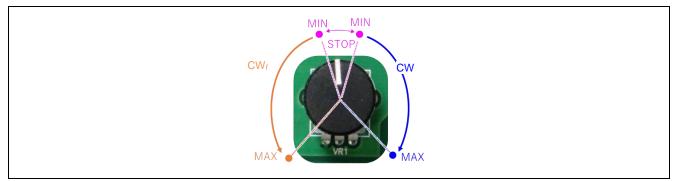


Figure 8. Control of motor rotation speed



The following shows the normal and abnormal states. This sample software defines the shaft deviation as the abnormal state. You can reproduce the abnormal state by pressing the universal plate to bend the air tube a little. Please lightly press the universal plate with finger like a Figure 10 because a strong pressing force may result in motor stop. As a guide, it is reach 0.3A when the motor rotation speed is 1000rpm.

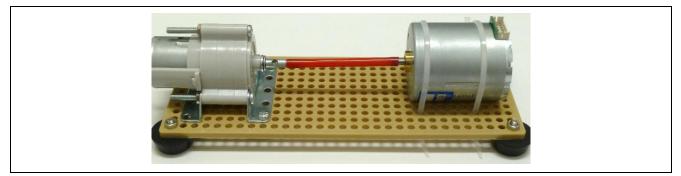


Figure 9. Normal State

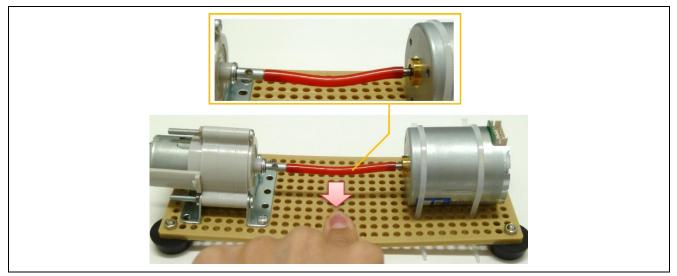


Figure 10. Abnormal State

7. Reference information

The following describes the reference information of simple motor bench evaluation. If you can't get an expected AI inference result, load of simple motor bench may not be appropriate. Please adjust it by referring to the peak current value in the following table. The peak current value and AI inference result are average value of 10 seconds that is calculated from wave monitor tool log.

Motor Motor		Motor bench A		Motor bench B		Motor bench C	
Rotation Speed (*)	Load	Peak Current (A)	Al Inference Result (%)	Peak Current (A)	Al Inference Result (%)	Peak Current (A)	Al Inference Result (%)
1000mm	Normal	0.121	0	0.130	15	0.113	13
1000rpm	Abnormal	0.306	84	0.407	100	0.285	93
4500	Normal	0.124	1	0.141	0	0.124	0
1500rpm	Abnormal	0.318	98	0.537	100	0.327	88
2000rpm	Normal	0.135	5	0.156	6	0.131	1
	Abnormal	0.285	95	0.531	96	0.290	96

*: Adjusting the motor rotation speed displayed in wave monitor tool.



Appendix2. MCU Software: detailed information

1. Memory Usage

Table 6-3. Memory Usage

ltem	Total Size	Description	
RAM	38.89 KB	-	
ROM	38.34 KB	ROM data section : 8.44 KB	
		Program section : 29.90 KB	

2. CPU Load

Table 6-4. CPU Load

Item	Processing Time	CPU Load Factor
50 [us] period interrupt (carrier interrupt) process	12.5µs	25.00%
500 [us] period interrupt process	2.4µs	0.48%
FFT process (fExecuteFFT()) (*)	2128.7µs	0.95%
e-AI inference process (AI_Inference()) (*)	316.7µs	0.14%

* : Except interrupt processing time



3. Smart Configurator Settings

i. Clock settings

Table 6-5 lists the clock settings for the sample software.

Table 6-5. Clock Settings

Item	Description
VCC	5V
Main clock	Select ON
Oscillation source	Oscillator
Frequency	8MHz
PLL circuit division ratio	x1
PLL circuit multiplication ratio	x20.0
SCKCR(FCLK[3:0])	x1/4 (FCLK=40MHz)
SCKCR(ICLK[3:0])	x1 (ICLK=160MHz)
SCKCR(PCLKA[3:0])	x1/2 (PCLKA=80MHz)
SCKCR(PCLKB[3:0])	x1/4 (PCLKB=40MHz)
SCKCR(PCLKC[3:0])	x1 (PCLKC=160MHz)
SCKCR(PCLKD[3:0])	x1/4 (PCLKD=40MHz)
SCKCR(BCK[3:0])	x1/4 (BCLK=40MHz)

Note: Default values are used for settings not listed here.

ii. CMT1

CMT1 creates the motor's 3 shunt current A/D sampling frequency (2kHz).

Table 6-6 shows the settings for CMT1.

Table 6-6. CMT1 Settings

Item	Description
Clock setting	PCLK/8
Interval time	500 μ s
Enable compare match interrupt (CMI1)	Select ON
Interrupt priority	11

Note: Default values are used for settings not listed here.



iii. SCI8

Use SCI8 to carry out serial communication between RX66T and the PC. FTDI's USB-serial converter cable C232HM-EDHSL-0 serves as the serial communication interface, and transfers are carried out in the MPSSE(*1) mode. To enable this, the SCI8 must be set to asynchronous mode, and clock output from the SCK8 pin. Also, use the CTS#8 pin for flow control.

*1: Multi-Protocol Synchronous Serial Engine

Table 6-7 lists the settings for SCI8.

Table 6-7	SCI8	Settings
-----------	------	----------

Item	Description
Communication method	SCI asynchronous mode
Start bit detection	When RXD8 pin is Low
Data bit length	9 bits
Parity	none
Stop bit	1 bit
Data transfer direction	LSB first
Transfer clock	Internal clock (PCLKB)
Bit rate	5,000,000
Bit modulation function	Enabled
SCK8 pin function	Clock output
Hardware flow control	CTS8#
Send data processing	Processed by DMAC
Receive data processing	Processed in interrupt service routine
TXI8 priority	12
RXI8 priority	8
Receive error interrupt enable (ERI8)	Enabled
TEI8, ERI8 priority (group BL1)	Level 15 (Notes2)
Callback function setting	Send complete, receive complete, receive error
Pins used	TXD8: PA4/TXD8 (pin 37)
	RXD8: PD1/RXD8 (pin 24)
	SCK8: PA3/SCK8 (pin 38)
	CTS8: P30/CTS8# (pin 63)

Notes1. Default values are used for settings not listed here.

Notes2. This is defined in the sample code in Reference Document [2]. Please do not change.

The following code is added to set the 9th bit of send data initial value to '0'. Target file: Config_SCI8_user.c (output by smart configurator) Target function: R_Config_SCI8_Create_UserInit function (created by smart configurator)

```
void R_Config_SCI8_Create_UserInit(void)
{
    /* Start user code for user init. Do not edit comment generated here */
    /* Set 9th bit to "0" */
    SCI8.TDRHL.BYTE.TDRH = 0xFE;
    /* End user code. Do not edit comment generated here */
}
```



iv. DMAC0

Table 6-8 lists the settings for DMAC0.

Table 6-8. DMAC0 Settings

Item	Setting Value
Activation factor	Set to SCI8 (TXI8)
Activation factor flag control	At the start of transfer, clear the interrupt flag that became the activation factor
Transfer mode	Normal mode
Transfer data size	8 bits
No. of transfers	1 (set in application at time of transfer)
Transfer origin address	0x00000000 (set in application at time of transfer)
Transfer origin address update method	Increments
Transfer destination address	0x00000000 (set separately in user initial setting section)
Transfer destination address update method	Fixed address
Interrupt setting (DMAC0I)	Enable transfer complete interrupt
Interrupt priority	8

Note: Default values are used for settings not listed here.

The following code is added to set the DMAC0 transfer address to the SCI8 'send register'. Target file: Config_DMAC0_user.c (output by smart configurator) Target function: R_ConfigCMAC0_Create_UserInit function (created by smart configurator)

```
void R_Config_DMAC0_Create_UserInit(void)
{
    /* Start user code for user init. Do not edit comment generated here */
    DMAC0.DMDAR = (void *) &SCI8.TDRHL.BYTE.TDRL;
    /* End user code. Do not edit comment generated here */
}
```



v. IRQ1

Table 6-9 lists the settings for IRQ1.

Table 6-9.IRQ1 Settings

Item	Setting Value
Detect type	Rising and falling edges
Digital filter	none
Interrupt priority	Level 12
Pins used	PE4/IRQ1 (pin 8)

Note: Default values are used for settings not listed here.

The following code is added to invert the level of the IRQ1 pin and output from the I/O port.

Target file: Config_ICU_user.c (output by smart configurator)

①Target function: R_ConfigCMAC0_Create_UserInit function (created by smart configurator)

```
void R_Config_ICU_Create_UserInit (void)
{
    /* Start user code for user init. Do not edit comment generated here */
    /* Initial setting of GPIO used for FSCTS signal inversion */
    /* PE4/IRQ1(IN) -> ~P31(OUT) -> P30/CTS8#(IN) */
    PORT3.PODR.BIT.B1 = ~PORTE.PIDR.BIT.B4;
    /* Set P31 to the output port */
    PORT3.PDR.BIT.B1 = 1;
    /* End user code. Do not edit comment generated here */
}
```

②Target function: r_Config_ICU_irq1_interrupt function (created by smart configurator)

```
static void r_Config_ICU_irq1_interrupt(void)
{
    /* Start user code for r_Config_ICU_irq1_interrupt. Do not edit comment
generated here */
    /* Invert the FSCTS signal */
    PORT3.PODR.BIT.B1 = ~PORTE.PIDR.BIT.B4;
```

/* End user code. Do not edit comment generated here */
}



4. Functions

Table 6-10 lists the functions used in main processing. The functions in bold lettering are new additions or have been updated.

Function Name	Description	
clrpsw_i()	Disables interrupts	
R_MTR_InitHardware()	Initializes motor peripheral functions	
R_MTR_InitBoardUi()	Initializes user interface	
software_init()	Initializes variables	
R_MTR_InitControl()	Initializes three-phase vector motor control	
ics2_init()	Initializes for use of "Renesas Motor Workbench" tools	
R_MTR_ExecEvent()	Executes FOC control events	
R_Systeminit()	Initializes sensor peripheral functions	
setpsw_i()	Enables interrupts	
R_MTR_ChargeCapacitor()	Waits for bus voltage stabilization	
MotionSensorInit()	Initializes AI inference processing	
board_ui()	Motor control processing	
ics_ui()	Processing for use of "Renesas Motor Workbench"	
MotionSensorMonitor()	Al inference processing	
R_MTR_ClearWdt()	Clears WDT	

Table 6-11 lists the functions used for motor control processing.

Function Name	Description
R_MTR_GetStatus()	Acquires motor status
get_sw1()	Acquires SW1 position
get_vr1()	Acquires VR1 position
R_MTR_SetSpeed()	Sets rotation speed command value
get_sw2()	Acquires SW2 state

Table 6-12 lists the functions used for AI inference processing.

Table 6-12. Functions used for AI Inference Processing

Function Name	Description	
fGetAdData()	Acquires A/D conversion value	
fSetADSendData()	Creates A/D conversion result send data	
fCalcFrequencySpectrum()	Executes FFT operation, acquires frequency spectrum	
fExecuteFFT()	Executes FFT operation	
fInitFft()	Initializes FFT operation	
fGetMotorData()	Acquires rotation speed and peak current	
fSendFtdi()	Sends data to PC	
fPcCommandRecv()	Analyzes PC command	
fPcGetData()	Acquires PC command	
fUpadteMovingAverage()	Updates AI inference value moving average data	
fGetMovingAverage()	Acquires AI inference value moving average data	



5. Constants

Table 6-13 lists the constants used for AI inference processing. The blue area indicates constants used for the FFT operation used by the DSP library.

Table 6-13. Constants (MotionSensor.h)

MotionSensor.h		
Constant Name	Setting Value	Description
DEF_PCLKB	4000000.0	PCLKB setting value(Unit: MHz)
DEF_CMT_CLK8	DEF_PCLKB / 8.0	CMT1 operating clock
DEF_DefaultSamplingFrequency	2000	Default sampling frequency value (Unit: Hz)
DEF_MinSamplingFrequency	1000	Minimum sampling frequency (Unit: Hz)
DEF_MaxSamplingFrequency	8000	Maximum sampling frequency (Unit: Hz)
DEF_DefaultSamplingCount	512	Default sampling count
DEF_SamplingCount128	128	Sampling count (128)
DEF_SamplingCount256	256	Sampling count (256)
DEF_SamplingCount512	512	Sampling count (512)
DEF_SamplingCount1024	1024	Sampling count (1024)
DEF_MaxSamplingCount	DEF_SamplingCount512	Maximum sampling count
DEF_MinSamplingCount	DEF_SamplingCount128	Minimum sampling count
DEF_DefaultOverlapSampling	64	Default overlap size
DEF_MinOverlapSampling	16	Minimum overlap size
DEF_MaxOverlapSampling	128	Maximum overlap size
DEF_FFT_NUM_BITREV	240	No. of elements in bit reverse table
DEF_SamplingRingBuffer	1024	Sampling ring buffer size
DEF_HeaderSize	7	Send data header byte size
DEF_SendAdMonitor	1	"AD converted value" send command
DEF_SendFrequencyMonitor	2	"Frequency spectrum" send command "
DEF_StartMonitor	1	"Monitor start" receive command
DEF_StopMonitor	2	"Monitor stop" receive command
DEF_SetUpSampling	3	"Sampling count setup" receive command
DEF_PcRecvBuffSize	128	Receive buffer size from PC
DEF_PcRecvTimeOut	100	Receive timeout time from PC (Unit: 10msec)
DEF_MovingAverageMinCount	1	Al inference moving average minimum count
DEF_MovingAverageMaxCount	100	Al inference moving average maximum count
DEF_DefaultMovingAverageMaxCount	20	Default AI inference moving average count
DEF_ShuntCurrentSampling	1	Current mode
DATA_CROPPING_PEAK	1	Setting of cropping data around peak value
DATA_CROPPING	2	Setting of cropping data specified range
DATA_CROPPING_NONE	3	Setting of not cropping data



6. Variables

Table 6-14 lists the global variables used for AI inference processing. The blue area indicates variables used for the FFT API functions in the DSP library.

Table 6-14. Global Variables (MotionSensor.c)

MotionSensor.c					
Type Name	Variable Name	Description			
ST_SamplingRingBuffer	gv_SamplingRingBuffer	Ring buffer for A/D sampling			
uint16_t	gv_SamplingCounter A/D sampling counter				
int16_t	gv_FrameSamplingEnd	Acquisition end position notification for 1 frame of A/D sampling buffer			
int16_t	gv_AD0Bffer[(DEF_MaxSamplingCount * 2)A/D conversion result (U- DEF_MinOverlapSampling]phase) buffer 7				
int16_t	gv_AD1Bffer[(DEF_MaxSamplingCount * 2) - DEF_MinOverlapSampling]	A/D conversion result (V phase) buffer			
int16_t	gv_AD2Bffer[(DEF_MaxSamplingCount * 2) - DEF_MinOverlapSampling]	A/D conversion result (W phase) buffer			
int16_t	gv_RspiSendStatus	FTDI send status			
int32_t	gs_fft_VecCplxMagi32[DEF_MaxSamplingC Complex magnitude value storage buffer				
cplxi32_t	gs_fft_buf[(DEF_MaxSamplingCount/2)] Storage area for result of "R_DSP_FFT_i16ci32" function operation (sampling count/2)				
vector_t	gs_fft_time = {DEF_MaxSamplingCount, NULL} Argument for "R_DSP_FFT_i16ci32" functi (displays input buffer)				
vector_t	gs_fft_freq = {(DEF_MaxSamplingCount/2), gs_fft_buf} Argument for "R_DSP_FFT_i16ci32" func (displays output buffer)				
vector_t	gs_fft_mag = {(DEF_MaxSamplingCount/2), gs_fft_VecCplxMagi32}				
r_dsp_fft_t	gs_fft_handle = {DEF_MaxSamplingCount, 0}; FFT function handle				
int16_t	gs_fft_twiddles[(DEF_MaxSamplingCount+(DEF_MaxSamplingCount/2))] Rotation factor buffer				
Int32_t	gs_fft_bitrev[DEF_FFT_NUM_BITREV] Bit reverse buffer				
float	gv_DecibelsBelowFullScale A/D converter full scale value (unit: dB) Working buffer for frequency conversion calculation				
float	gv_SquareSamplingHalf Working buffer for frequency conversion calculation of (sampling count/2)^2 7				
int16_t	gv_MonitorStatus	Measurement start/stop status			
ST_SamplingMonitor	gv_SamplingMonitor Monitor send data (stores da such as frequency spectrun				
uint8_t	gv_RecvData Receive data (data to confirm receive is valid at initialization)				
ST_PcRecvRingBuffer	gv_PcRecvRingBuffer	Ring buffer for receive from PC			
uint16_t	gv_PcRecvStatus	Status of receive from PC			



uint8_t	gv_PcCommand	Receive command from PC
uint32_t	gv_PcRecvTimer	Monitor timer for receive from PC
ST_SamplingConditions	gv_SamplingConditions	Sampling conditions
uint16_t	gv_SamplingSize	Sampling buffer size
uint16_t	gv_Buffer2to1Overlap	Stores sampling buffer overlap sample count
uint16_t	gv_Frame1End	Stores end position of even frames
uint16_t	gv_Frame2End Stores end position of odd frames	
ST_MovingAverage	gv_MovingAverage	Working buffer for AI inference moving average calculation



The following lists structures used in the e-AI sample code that is run in this sample software. The items highlighted in gray are structures or member names that will be eliminated in the future.

```
/* A/D sampling buffer structures */
typedef struct {
 int16 t
                     m AdOValue; /* A/D conversion result (U phase) buffer */
                     m AdlValue; /* A/D conversion result (V phase) buffer */
 int16 t
                     m Ad2Value; /* A/D conversion result (W phase) buffer */
 int16 t
} ST SamplingRingData;
/* A/D ring buffer structures */
typedef struct {
 uint16_t
                       m Write; /* Ring buffer write position */
                       m Read; /* Ring buffer read position */
 uint16 t
 ST SamplingRingData m SamplingRingData[DEF SamplingRingBuffer]; /* Ring
buffer */
} ST SamplingRingBuffer;
/* Information structures (frame length 128 samples) */
typedef struct {
                       m FrequencySpectrum[3][DEF SamplingCount128/2]; /*
 float
Stores frequency spectrum */
                       m RotationSpeed; /* Stores rotation speed */
 float
 float
                       m PeekCurrent;
                                          /* Stores peak current value */
                                          /* Stores AI inference value (%)*/
 int8 t
                       m AiResult;
 float
                       m_AiMovingAverage;/* Stores AI inference value
(%)moving average */
} ST Sampling128;
/* Information structures (frame length 256 samples) */
typedef struct {
                       m FrequencySpectrum[3][DEF SamplingCount256/2];
 float
 float
                       m RotationSpeed;
 float
                       m PeekCurrent;
 int8 t
                       m AiResult;
 float
                        m AiMovingAverage;
} ST Sampling256;
Information structures (frame length 512 samples)
typedef struct {
                       m FrequencySpectrum[3][DEF SamplingCount512/2];
 float
 float.
                       m RotationSpeed;
 float
                       m PeekCurrent;
 int8 t
                       m AiResult;
 float
                       m AiMovingAverage;
} ST Sampling512;
Information structures (frame length 1024 samples)
typedef struct {
 float
                       m FrequencySpectrum[3][DEF SamplingCount1024/2];
 float
                       m RotationSpeed;
 float
                       m PeekCurrent;
 int8 t
                       m AiResult;
 float
                        m AiMovingAverage;
} ST Sampling1024;
```



```
/* Serial communication buffer structures and unions */
typedef struct {
                       m Header[DEF HeaderSize]; /* Stores communication
  uint8 t
header */
                       m Cmd; /* Communication control command, 01: A/D
  uint8 t
conversion value, 02: FFT processed value */
  union {
      ST SamplingData m SamplingData; /* Entity of 3 shunt current buffer
structure */
     ST_Sampling128 m_Sampling128; /* Entity of data structures */
     ST_Sampling256 m_Sampling256;
ST_Sampling512 m_Sampling512;
      ST_Sampling1024 m Sampling1024;
  } UN Sampling;
} ST SamplingMonitor;
/* Serial communication ring buffer structure */
typedef struct {
uint16 t
                       m Write; /* Ring buffer write position */
                       m Read; /* Ring buffer read position */
uint16 t
 uint8 t m RingData[DEF PcRecvBuffSize]; /* Ring buffer */
} ST PcRecvRingBuffer;
/* Moving average operation buffer structure */
typedef struct {
uint16 t
                       m MaxCount; /* Acquired data count */
                       m BufferFull; /* Buffer full flag */
uint16 t
                       m Count; /* Moving average length */
 uint16 t
 uint32 t
                       m Sum;/* Moving average sum buffer */
 uint16 t
                        m AiInference[DEF MovingAverageMaxCount]; /* AI
inference value buffer */
} ST MovingAverage;
/* Sampling conditions structure */
typedef struct {
                      m_SamplingFrequency; /* Sampling frequency */
m_SamplingCount; /* Sampling count */
 uint16 t
 uint16 t
                      m_SamplingOverLap; /* Overlap size */
m_MovingAverageMaxCount; /* Moving average maximum
 uint16 t
 uint16 t
count */
                       m_SamplingMode; /* Smampling mode */
uint16 t
                       m CheckSum; /* Checksum */
uint32 t
} ST SamplingConditions;
```



Revision History

		Descript	ion
Rev.	Date	Page	Summary
1.00	June. 20, 2019	-	First Edition issued
2.00	Oct. 07, 2019	7	Hardware Block Diagram, corrected.
		12	4.3 Resources, added.
		19	Flowchart for getting A/D conversion result of motor current value, added.
		22	4.7.4 Preprocessing specifications, added.
		40	v. IRQ1, added.
		42	Added the constants.



General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power is supplied until the power reaches the level at which resetting is specified.

3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (Max.) and V_{IH} (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{IL} (Max.) and V_{IH} (Min.)

7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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